STF3LN80K5

N-channel 800 V, 2.75 Ω typ., 2 A MDmesh™ K5 Power MOSFET in a TO-220FP package

TO-220FP

Features
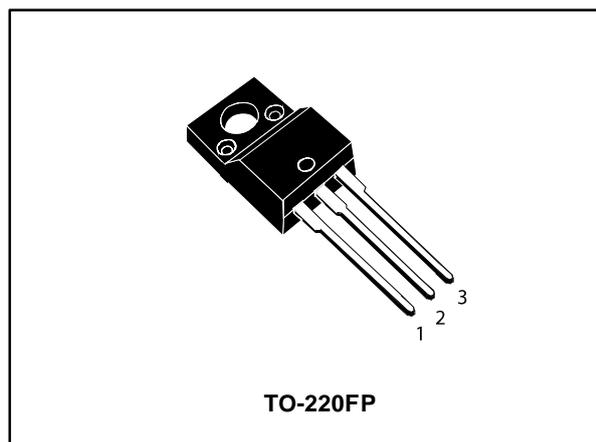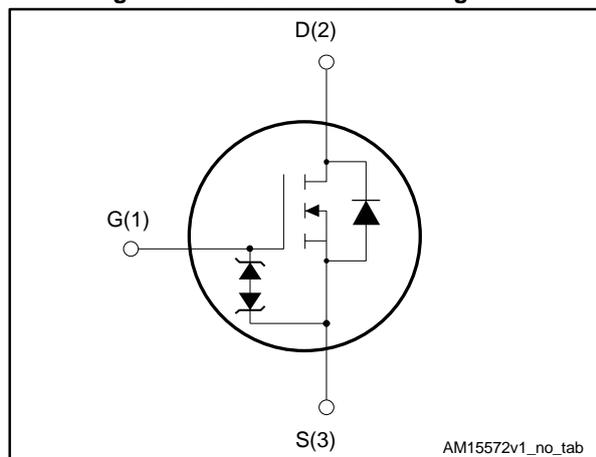
Order code	V_{DS}	$R_{DS(on)}$ max	I_D
STF3LN80K5	800 V	3.25 Ω	2 A

- Industry's lowest $R_{DS(on)}$ x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Figure 1: Internal schematic diagram

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Table 1: Device summary

Order code	Marking	Package	Packing
STF3LN80K5	3LN80K5	TO-220FP	Tube

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Contents

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 30	V
I_D [1]	Drain current (continuous) at T_C = 25 °C	2	A
I_D [1]	Drain current (continuous) at T_C = 100 °C	1.25	A
I_D [2]	Drain current (pulsed)	8	A
P_{TOT}	Total dissipation at T_C = 25 °C	20	W
V_{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_C = 25 °C)	2500	V
dv/dt [3]	Peak diode recovery voltage slope	4.5	V/ns
dv/dt [4]	MOSFET dv/dt ruggedness	50	V/ns
T_{stg}	Storage temperature range	- 55 to 150	°C
T_j	Operating junction temperature range	- 55 to 150	°C

Notes:

[1]Limited by maximum junction temperature.

[2]Pulse width limited by safe operating area.

[3]I_{SD} ≤ 2 A, di/dt ≤ 100 A/µs; V_{DSpeak} < $V_{(BR)DSS}$, V_{DD} = 640 V

[4]V_{DS} ≤ 640 V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{thj\text{-}case}$	Thermal resistance junction-case	6.25	°C/W
$R_{thj\text{-}amb}$	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	0.7	A
E_{AS}	Single pulse avalanche energy (starting T_j = 25°C, I_D = I_{AR}; V_{DD} = 50 V)	155	mJ

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5: On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	I_D = 1 mA, V_{GS} = 0 V	800			V
I_{DSS}	Zero gate voltage drain current	V_{DS} = 800 V, V_{GS} = 0 V			1	μA
		V_{DS} = 800 V, V_{GS} = 0 V, T_C = 125 °C[(1)]			50	μA
I_{GSS}	Gate body leakage current	V_{GS} = ± 20 V, V_{GS} = 0 V			±10	μA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 100 μA	3	4	5	V
$R_{DS(on)}$	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 1 A		2.75	3.25	Ω

Notes:

[(1)]Defined by design, not subject to production test.

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0 V	-	102	-	pF
C_{oss}	Output capacitance		-	11	-	pF
C_{rss}	Reverse transfer capacitance		-	0.1	-	pF
C_{otr}[(1)]	Equivalent capacitance time related	V_{DS} = 0 to 640 V, V_{GS} = 0 V	-	20	-	pF
C_{oer}[(2)]	Equivalent capacitance energy related		-	7	-	pF
R_G	Intrinsic gate resistance	f = 1 MHz, I_D = 0 A	-	12	-	Ω
Q_g	Total gate charge	V_{DD} = 640 V, I_D = 2 A, V_{GS} = 10 V (see *Figure 15: "Test circuit for gate charge behavior"*)	-	2.63	-	nC
Q_{gs}	Gate-source charge		-	0.91	-	nC
Q_{gd}	Gate-drain charge		-	1.53	-	nC

Notes:

[(1)]Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

[(2)]Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{DD} = 400 V, I_D = 1 A, R_G = 4.7 Ω, V_{GS} = 10 V (see *Figure 14: "Test circuit for resistive load switching times"* and *Figure 19: "Switching time waveform"*)	-	6.2	-	ns
t_r	Rise time		-	7	-	ns
$t_{d(off)}$	Turn-off delay time		-	30	-	ns
t_f	Fall time		-	26	-	ns

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		2	A
I_{SDM}[1]	Source-drain current (pulsed)		-		8	A
V_{SD}[2]	Forward on voltage	I_{SD} = 2 A, V_{GS} = 0 V	-		1.5	V
t_{rr}	Reverse recovery time	I_{SD} = 2 A, di/dt = 100 A/µs, V_{DD} = 60 V (see *Figure 16: "Test circuit for inductive load switching and diode recovery times"*)	-	210		ns
Q_{rr}	Reverse recovery charge		-	0.8		µC
I_{RRM}	Reverse recovery current		-	7.6		A
t_{rr}	Reverse recovery time	I_{SD} = 2 A, di/dt = 100 A/µs, V_{DD} = 60 V, T_j = 150 °C, (see *Figure 16: "Test circuit for inductive load switching and diode recovery times"*)	-	345		ns
Q_{rr}	Reverse recovery charge		-	1.2		µC
I_{RRM}	Reverse recovery current		-	7.2		A

Notes:

[1]Pulse width limited by safe operating area.

[2]Pulsed: pulse duration = 300 µs, duty cycle 1.5%.

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	I_{GS} = ± 1 mA, I_D = 0 A	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.
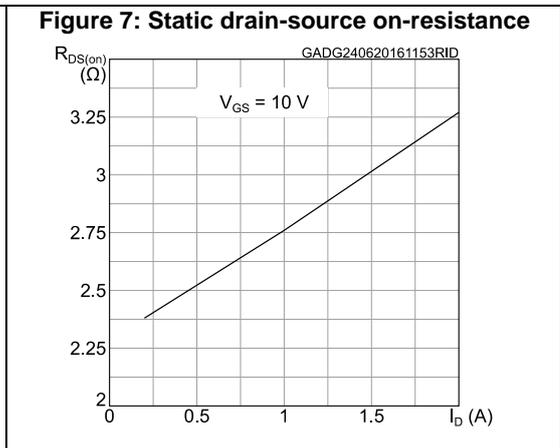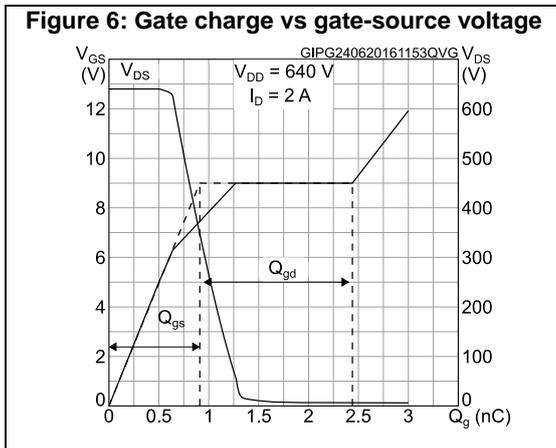
2.1   2.1 Electrical characteristics (curves)

Figure 2: Safe operating area

Figure 3: Thermal impedance

Figure 4: Output characteristics

Figure 5: Transfer characteristics

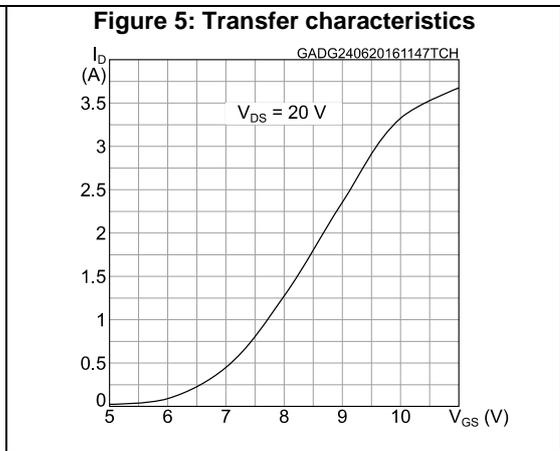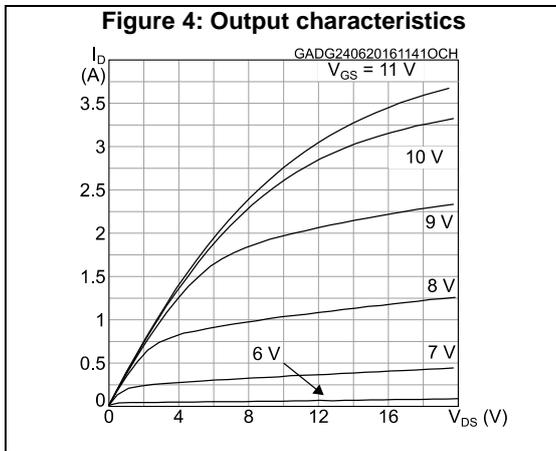Figure 6: Gate charge vs gate-source voltage

Figure 7: Static drain-source on-resistance

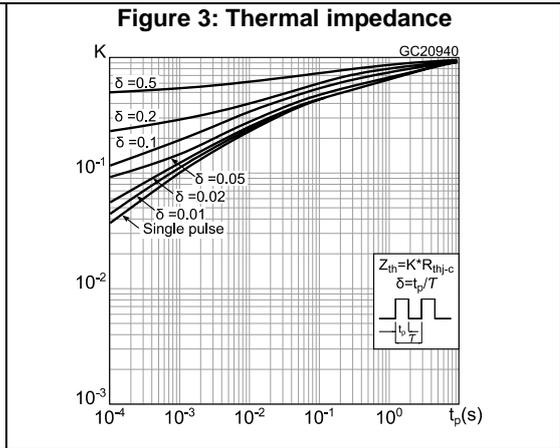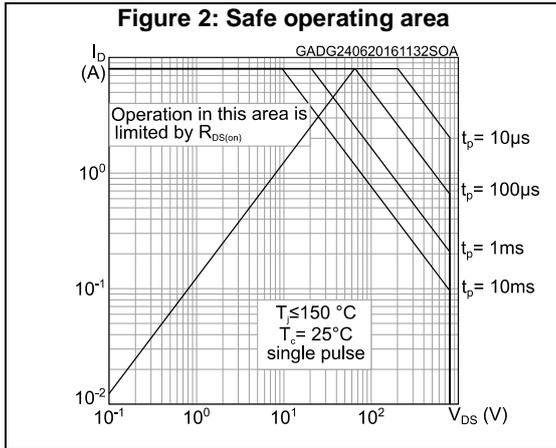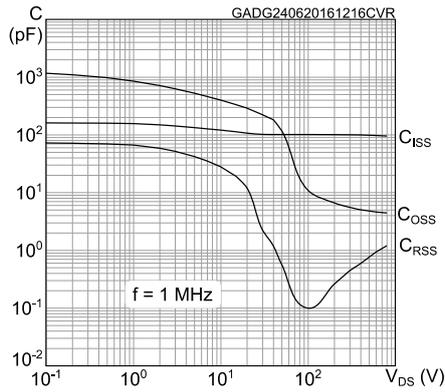**Figure 8: Capacitance variations**
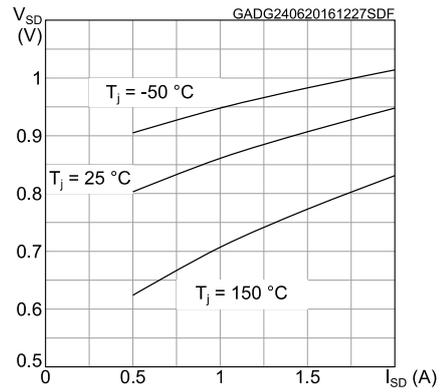

Figure 9: Source-drain diode forward characteristics

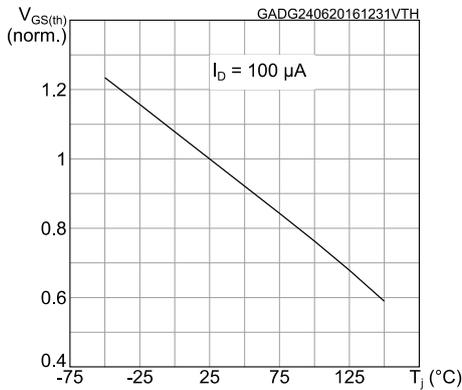
Figure 10: Normalized gate threshold voltage vs temperature

Figure 11: Normalized on-resistance vs temperature
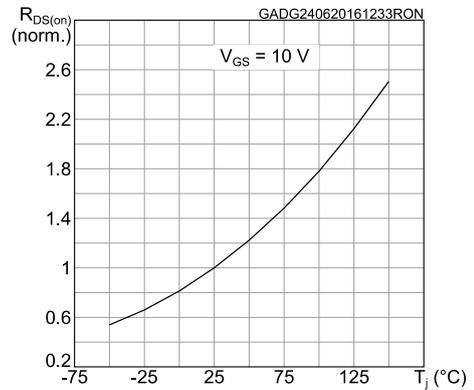
Figure 12: Normalized V(BR)DSS vs temperature
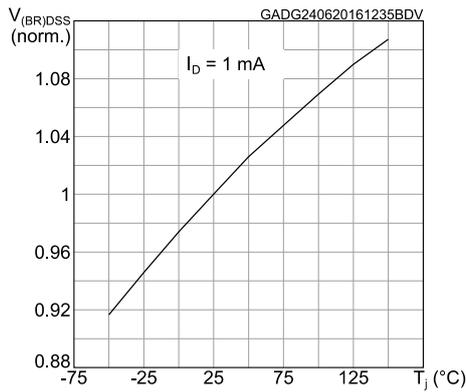
Figure 13: Maximum avalanche energy vs starting TJ
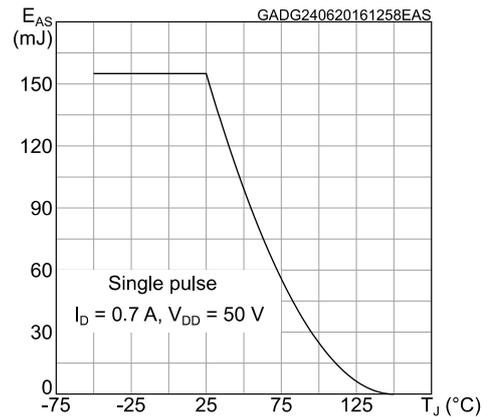
3 Test circuits

Figure 14: Test circuit for resistive load switching times
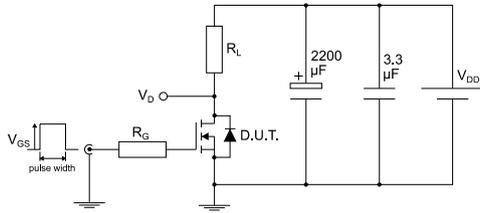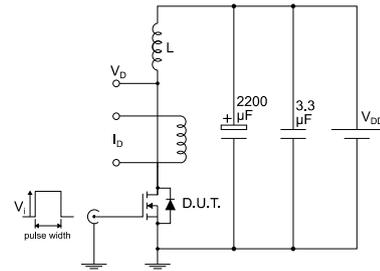

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Figure 15: Test circuit for gate charge behavior
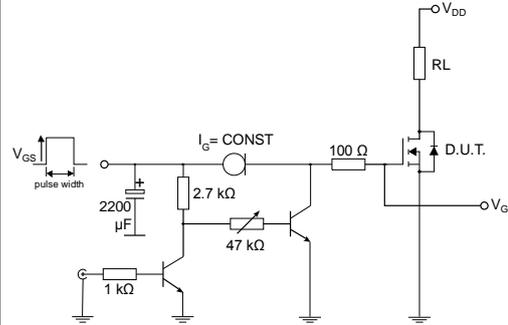
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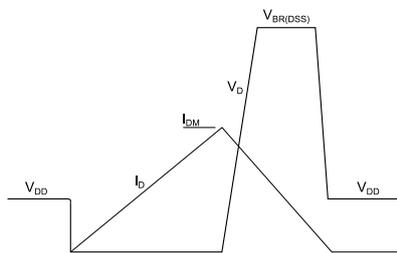**Figure 16: Test circuit for inductive load switching and diode recovery times**
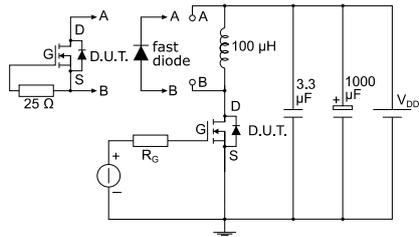
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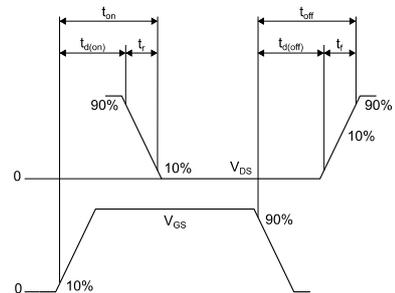
Figure 17: Unclamped inductive load test circuit

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Figure 18: Unclamped inductive waveform

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Figure 19: Switching time waveform

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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: ***www.st.com***. ECOPACK® is an ST trademark.

4.1 TO-220FP package information

Figure 20: TO-220FP package outline
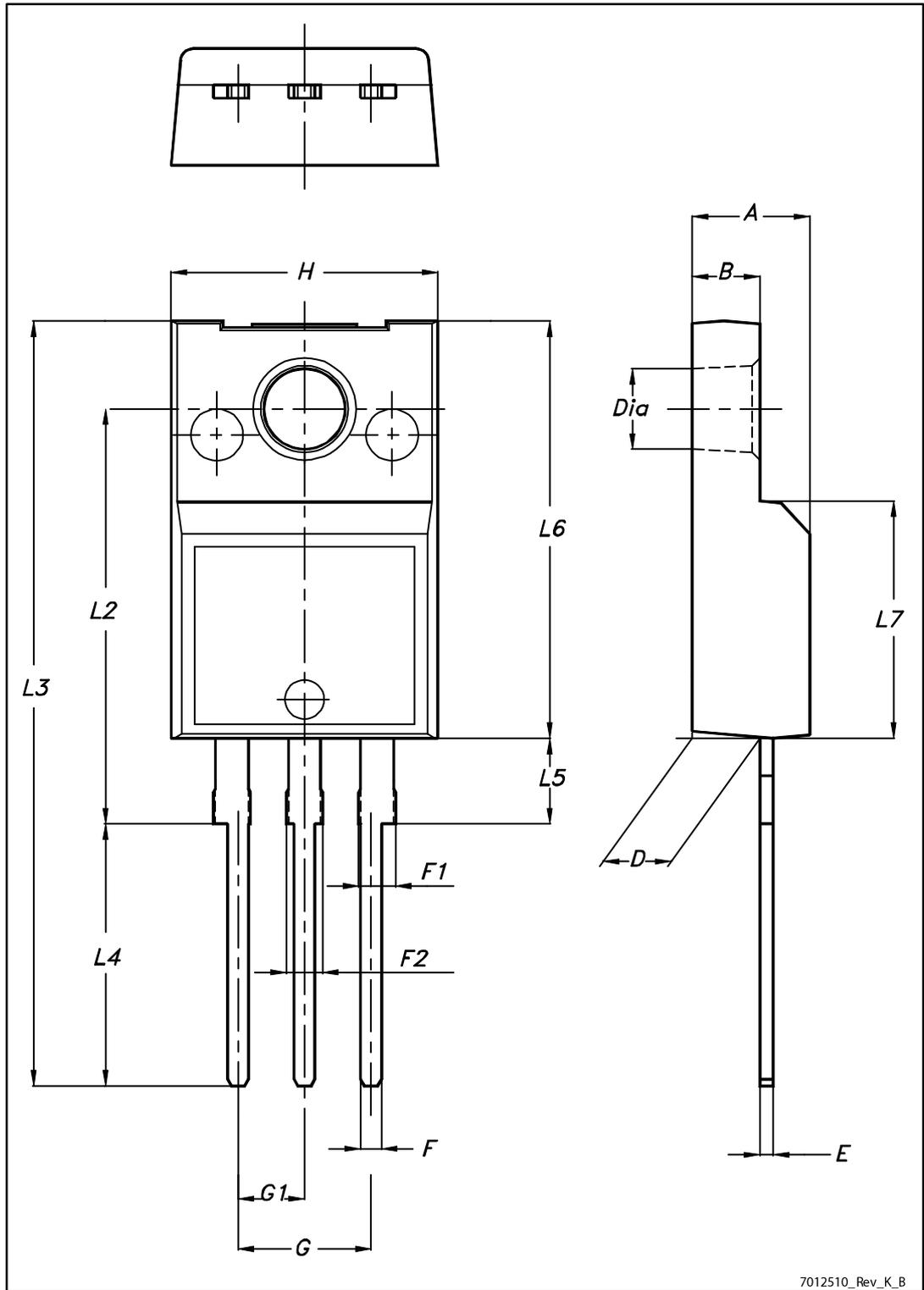
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Table 10: TO-220FP package mechanical data

Dim.	mm		
	Min.	**Typ.**	**Max.**
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
13-May-2015	1	Initial release
01-Jul-2016	2	Updated title and features in cover page. Updated *Table 2: "Absolute maximum ratings"* and *Section 2: "Electrical characteristics"*. Added *Section 2.1: "2.1 Electrical characteristics (curves)"*. Minor text changes.

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